

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of: : Customer Number: 89518  
: :  
Mou-Shiung Lin : Confirmation Number: 8665  
: :  
Application No.: 10/755,042 : Group Art Unit: 2815  
: :  
Filed: January 9, 2004 : Examiner: Jackson Jr, Jerome  
: :  
For: INTEGRATED CHIP PACKAGE STRUCTURE USING SILICON SUBSTRATE AND  
METHOD OF MANUFACTURING THE SAME

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**CERTIFICATE OF ELECTRONIC TRANSMISSION**  
I hereby certify that this correspondence is being electronically-  
transmitted to the United States Patent and Trademark Office on  
November 16, 2009  
/Tobi A. Terry/  
\_\_\_\_\_  
Tobi A. Terry

**PETITION FOR EXTENSION OF TIME**

Sir:

It is respectfully requested that the time for response to the Office Action dated June 16, 2009 be extended by two months to November 16, 2009.

Please charge the extension of time fee of \$490.00 to Deposit Account No. 502624.  
Please charge any additional fees or credit any overpayment to Deposit Account No. 502624.

Respectfully submitted,  
McDERMOTT WILL & EMERY LLP

/Dennis A. Duchene/

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**Date: November 16, 2009**

**Please recognize our Customer No. 89518  
as our correspondence address.**